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Publisher Correction: Integrated microthermoelectric coolers with rapid response time and high device reliability

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In the version of this Article originally published, in the Methods section 'Analytical calculation and FEM simulation' owing to a technical error, the first equation was incorrect as:

$$K_{\rm eff} = \frac{S_{\rm eff} \times T_0}{c}$$

It has now been replaced with the correct equation:

$$\Delta T = \frac{S_{\text{eff}} \times I \times T_{\text{c}} - \frac{1}{2}I^{2} \times R_{\text{eff}} - Q_{\text{c}}}{K_{\text{eff}}}$$

In addition, in the section 'Conclusions', the packing density mistakenly read '5,000 leg pairs per cm²' and has now been corrected to read '5,500 leg pairs per cm²'.

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